



PATENT  
8053-1015

**IN THE U.S. PATENT AND TRADEMARK OFFICE**

In re application of

Takekazu TANAKA

Conf. 1342

Application No. 10/602,044

Group 2814

Filed June 24, 2003

Examiner Alonzo Chambliss

SEMICONDUCTOR PACKAGE, AND  
PRODUCTION PROCESS FOR  
MANUFACTURING SUCH SEMICONDUCTOR  
PACKAGE

**AMENDMENT**

MS AMENDMENT

July 18, 2005

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In response to the Office Action mailed March 21, 2005,  
please amend the above-identified application as follows:

**Amendments to the Specification** begin on page 2 of this  
paper.

**Amendments to the Claims** are reflected in the listing  
of claims which begins on page 3 of this paper.

**Amendments to the Drawings** begin on page 10 of this  
paper and include an attached replacement sheet.

**Remarks** begin on page 11 of this paper.

An **Appendix** is attached following the signature page of  
this paper.